

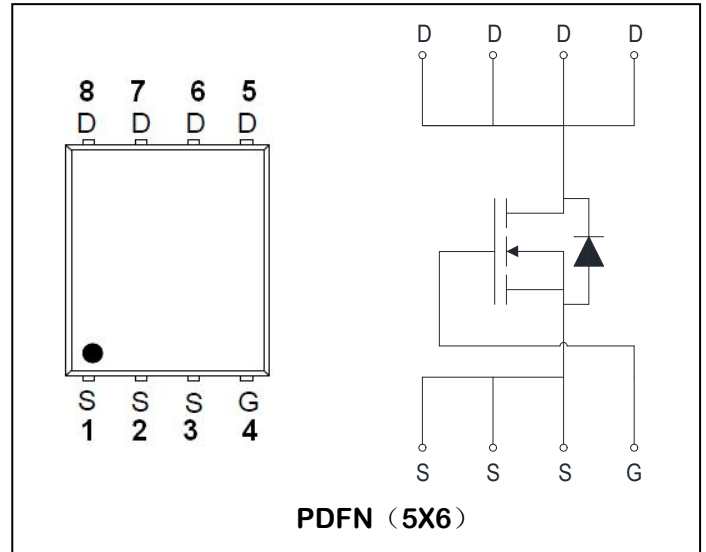
N-Channel Enhancement Mode Field Effect Transistor

PRODUCT SUMMARY

V_{DSS}	I_D	$R_{DS(ON)}$ (m Ω)
100V	68A	8m Ω

Features:

- Low Gate Charge for Fast Switching Application
- Low $R_{DS(ON)}$ to Minimize Conductive Loss
- 100% EAS Guaranteed
- Optimized $V_{(BR)DSS}$ Ruggedness
- Lead-Free,RoHS Compliant



Description:

The ADM68N10Q uses advanced trench technology and design to provide excellent $R_{DS(ON)}$ with low gate charge. It can be used in a wide variety of applications.

Absolute Maximum Ratings ($T_A = 25^\circ\text{C}$ unless otherwise specified)

Symbol	Parameter		Ratings	Unit
Common Ratings				
V _{DSS}	Drain-Source Voltage		100	V
V _{GSS}	Gate-Source Voltage		± 20	
T _J	Maximum Junction Temperature		150	°C
T _{STG}	Storage Temperature Range		-55 to 150	°C
I _S	Diode Continuous Forward Current	T _C =25°C	48	A
Mounted on Large Heat Sink				
I _{DM}	300μs Pulse Drain Current Tested ⁽²⁾	T _C =25°C	360	A
I _D	Continuous Drain Current ⁽¹⁾	T _C =25°C	68	A
		T _C =70°C	48	A
P _D	Maximum Power Dissipation	T _C = 25°C	108	W

Thermal Characteristics

Symbol	Parameter	Ratings	Unit
R_{thJC}	Thermal resistance junction-case max ⁽¹⁾	1.15	$^\circ\text{C/W}$
R_{thJA}	Thermal resistance junction-ambient max ⁽¹⁾	55	$^\circ\text{C/W}$

Electrical Characteristics (TA=25°C Unless Otherwise Noted)

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
On/off Characteristics						
V _{(BR)DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V, I _{DS} =250uA	100	--	--	V
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} =80V,V _{GS} =0V , T _J =25°C	--	--	1	uA
V _{GS(th)}	Gate Threshold Voltage	V _{DS} =V _{GS} , I _{DS} =250uA	1.2	--	2.3	V
I _{GSS}	Gate Leakage Current	V _{GS} =± 20V, V _{DS} =0V	--	--	± 100	nA
R _{DS(ON)}	Drain-SourceOn-stateResistance ⁽²⁾	V _{GS} = 10V, I _{DS} =13.5A	--	6.6	8.0	mΩ
		V _{GS} = 4.5V, I _{DS} =11.5A	--	8.7	10.5	
Dynamic Characteristics						
C _{iss}	Input Capacitance	V _{GS} =0V, V _{DS} =50V, Frequency=1MHz	--	3320	--	pF
C _{oss}	Output Capacitance		--	605	--	
C _{rss}	Reverse Transfer Capacitance		--	20	--	
Switching Characteristics						
t _{d(ON)}	Turn-on Delay Time	V _{DS} =50V, I _D = 13.5A, V _{GS} = 10V, R _{GEN} =3 Ω	--	10	--	nS
t _r	Turn-on Rise Time		--	6.5	--	
t _{d(OFF)}	Turn-off Delay Time		--	45	--	
t _f	Turn-off Fall Time		--	7.5	--	
Q _g	Total Gate Charge	V _{DS} =50V, V _{GS} = 10V, I _{DS} =13.5A	--	45	--	nC
Q _{gs}	Gate-Source Charge		--	9.5	--	
Q _{gd}	Gate-Drain Charge		--	4.8	--	
Avalanche Characteristics						
EAS	Single Pulse Avalanche Energy ⁽³⁾	V _{DD} =25V,L=0.3mH ,V _{GS} =1 0V,R _g =25 Ω , I _{AS} =35A T _J =25°C	61	--	--	mJ
Diode Characteristics						
V _{SD}	Diode Forward Voltage ⁽²⁾	I _{SD} = 1A, V _{GS} = 0	--	--	1.1	V
t _{rr}	Reverse Recovery Time	I _{SD} =13.5A, dI _{SD} /dt=100A/μs	--	33	--	ns
q _{rr}	Reverse Recovery Charge		--	150	--	nC

NOTES:

1. Surface Mounted on FR4 Board, t ≤ 10 sec.
2. The data tested by pulsed , pulse width ≤ 300us , duty cycle ≤ 2%
3. The Min. value is 100% EAS tested guarantee.

Typical Performance Characteristics

Figure 1: On-Region Characteristics

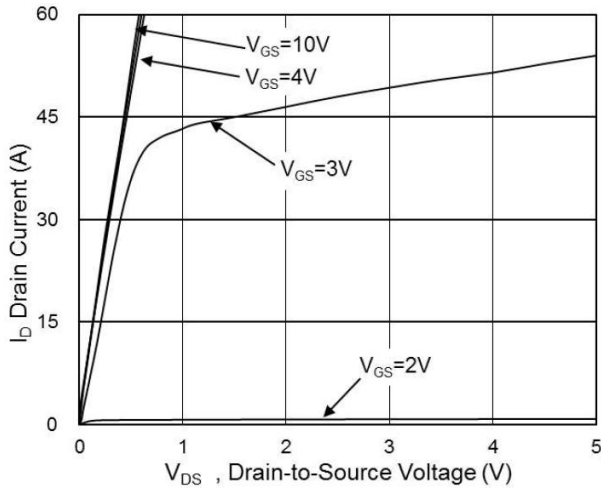


Figure 2: Normalized On-Resistance Vs. Temperature

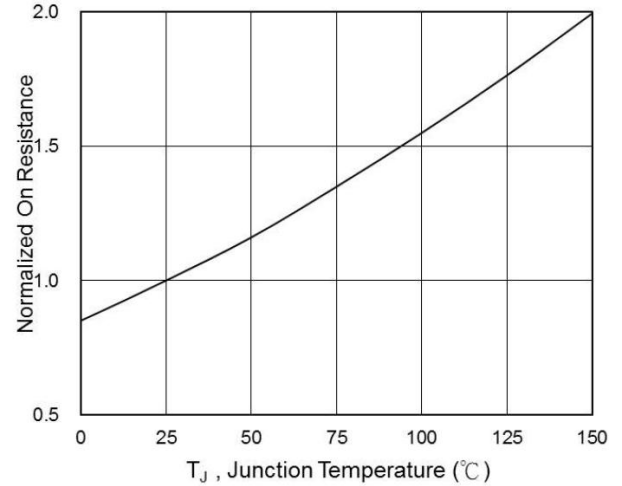


Figure 3: On-Resistance vs. G-S Voltage

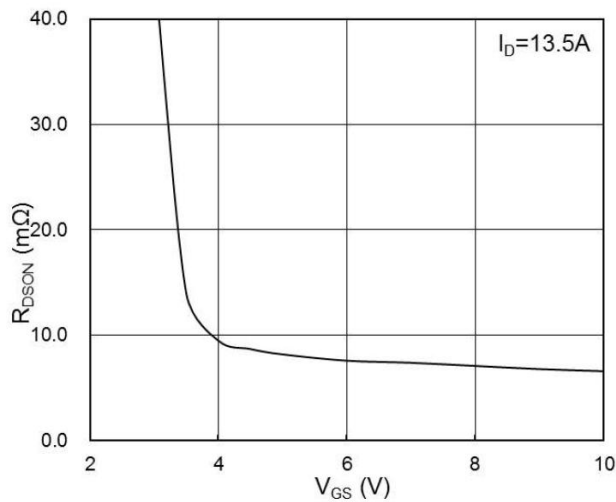


Figure 4: Gate Charge Waveform

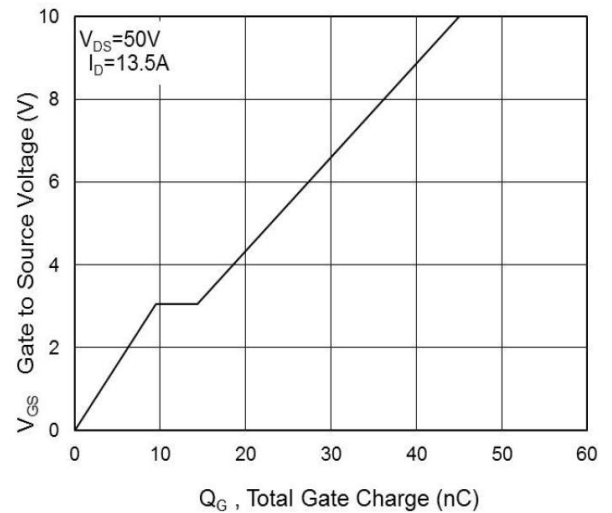


Figure 5: Threshold Voltage Vs. Temperature

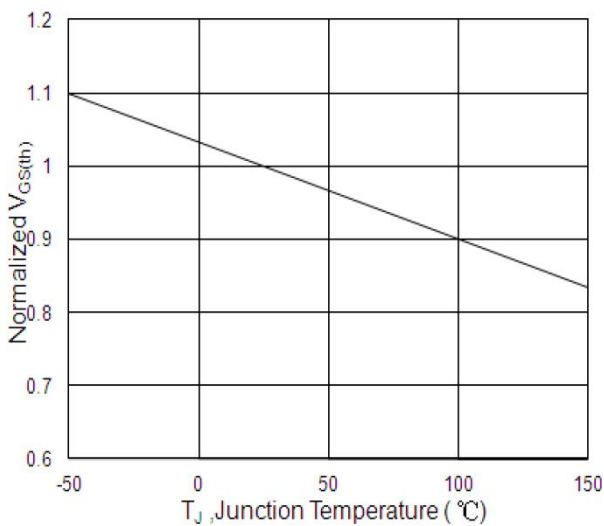


Figure 6: Maximum Safe Operation Area

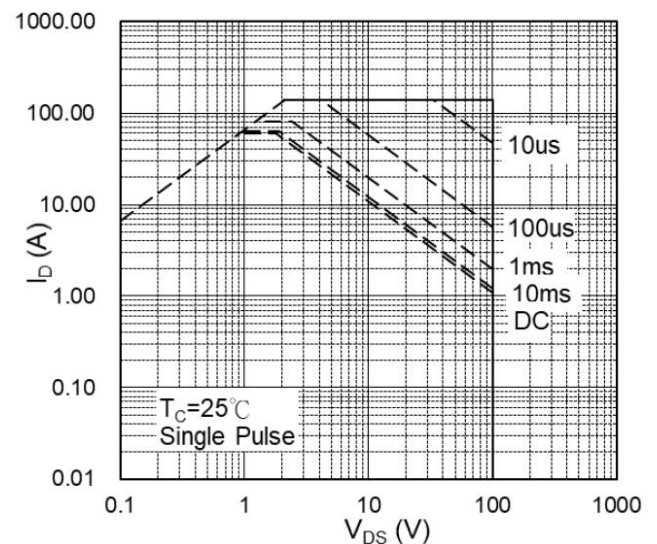


Figure 7: Capacitance vs Vds

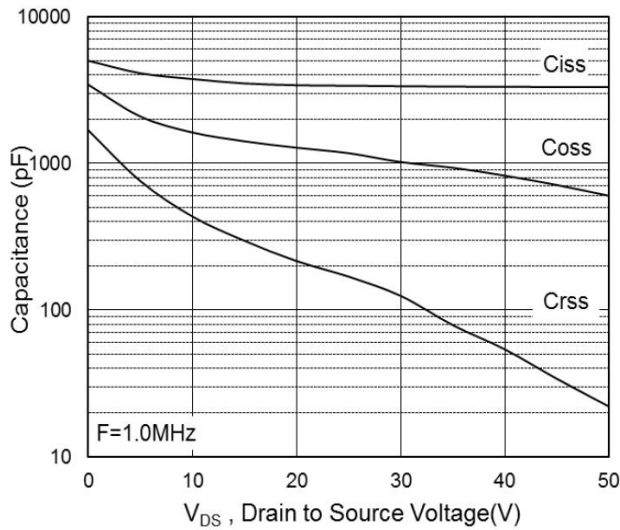


Figure 8: Typical Source-Drain Diode Forward Voltage

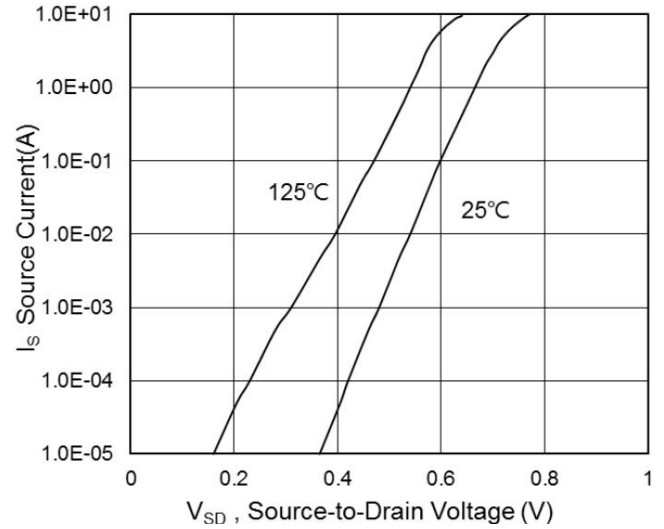


Figure 9: Effective Transient Thermal Response Curve

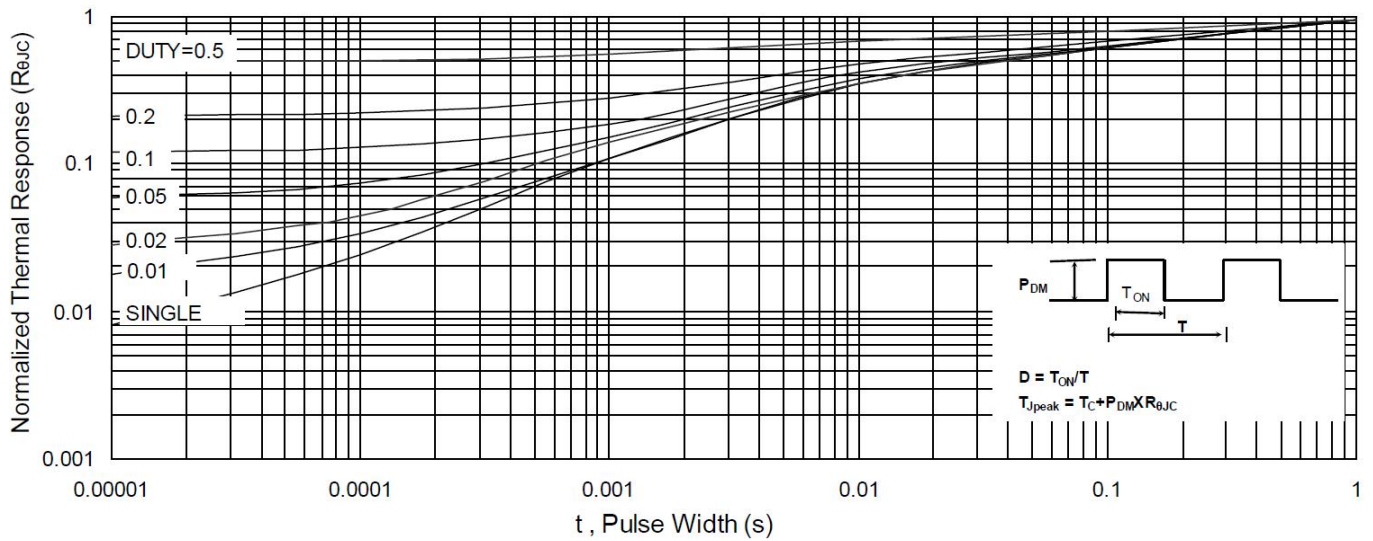


Figure 10: Switching Time Waveform

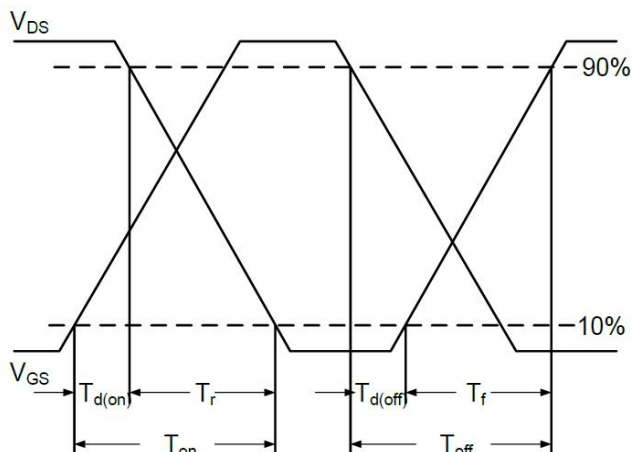
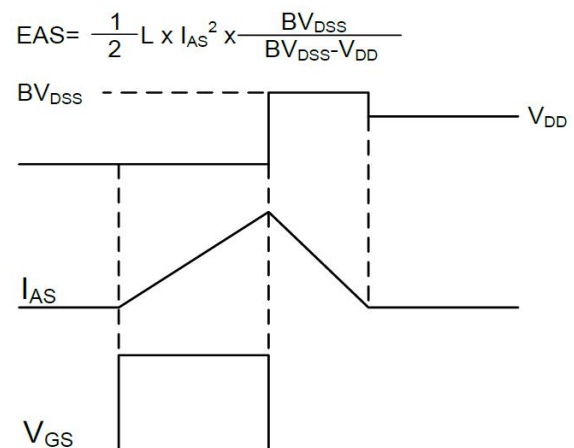
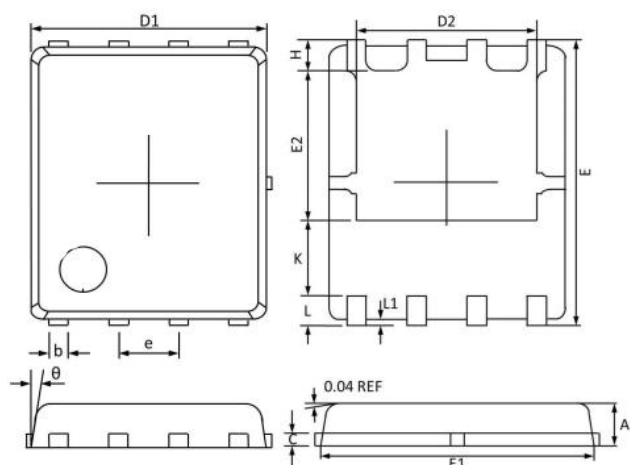


Figure 11: EAS Waveform



PACKAGE MECHANICAL DATA

PDFN (5X6) Package Dimension



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	0.800	1.100	0.031	0.043
b	0.330	0.510	0.013	0.020
c	0.200	0.300	0.008	0.012
D1	4.800	5.100	0.189	0.201
D2	3.610	4.100	0.142	0.161
E	5.900	6.200	0.232	0.244
E1	5.700	5.900	0.224	0.232
E2	3.350	3.780	0.132	0.149
H	0.410	0.700	0.016	0.028
K	1.100	1.500	0.043	0.059
e	1.270 TYP.		0.050 TYP.	
L	0.510	0.710	0.020	0.028
L1	0.060	0.200	0.002	0.008
θ	0°	12°	0°	12°

Ordering information

Part number	Package	Marking	Packing	Quantity
ADM68N10Q	PDFN5*6	M68N10Q	Embossed tape	2500pcs

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